## NUP4301 MR6, SZNUP4301MR6

## Low Capacitance Diode Array for ESD Protection in Four Data Lines

SZ/NUP4301MR6T1G is a micro-integrated device designed to provide protection for sensitive components from possible harmful electrical transients; for example, ESD (electrostatic discharge).

## Features

- Low Capacitance (1.5 pf Maximum Between I/O Lines)
- Single Package Integration Design
- Provides ESD Protection for JEDEC Standards JESD22

Machine Model = Class C
Human Body Model = Class 3B

- Protection for IEC61000-4-2 (Level 4)

$$
\begin{aligned}
& 8.0 \mathrm{kV} \text { (Contact) } \\
& 15 \mathrm{kV} \text { (Air) }
\end{aligned}
$$

- Ensures Data Line Speed and Integrity
- Fewer Components and Less Board Space
- Direct the Transient to Either Positive Side or to the Ground
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This is a $\mathrm{Pb}-$ Free Device*


## Applications

- USB 1.1 and 2.0 Data Line Protection
- T1/E1 Secondary IC Protection
- T3/E3 Secondary IC Protection
- HDSL, IDSL Secondary IC Protection
- Video Line Protection
- Microcontroller Input Protection
- Base Stations
- $\mathrm{I}^{2} \mathrm{C}$ Bus Protection

[^0]ORDERING INFORMATION

| Device | Package | Shipping $^{\dagger}$ |
| :---: | :---: | :---: |
| NUP4301MR6T1G | SC-74 <br> (Pb-Free) | $3,000 /$ <br> Tape \& Reel |
| SZNUP4301MR6T1G | SC-74 <br> (Pb-Free) | $3,000 /$ <br> Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


Brochure, BRD8011/D.

MAXIMUM RATINGS (Each Diode) ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Reverse Voltage | $\mathrm{V}_{\mathrm{R}}$ | 70 | Vdc |
| Forward Current | $\mathrm{I}_{\mathrm{F}}$ | 200 | mAdc |
| Peak Forward Surge Current | $\mathrm{I}_{\text {FM (surge) }}$ | 500 | mAdc |
| Repetitive Peak Reverse Voltage | $\mathrm{V}_{\text {RRM }}$ | 70 | V |
| Average Rectified Forward Current (Note 1) (averaged over any 20 ms period) | $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | 715 | mA |
| Repetitive Peak Forward Current | $\mathrm{I}_{\text {FRM }}$ | 450 | mA |
| Non-Repetitive Peak Forward Current $\begin{aligned} & \mathrm{t}=1.0 \mathrm{us} \\ & \mathrm{t}=1.0 \mathrm{~ms} \\ & \mathrm{t}=1.0 \mathrm{~s} \end{aligned}$ | $\mathrm{I}_{\text {FSM }}$ | $\begin{aligned} & 2.0 \\ & 1.0 \\ & 0.5 \end{aligned}$ | A |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. $F R-5=1.0 \times 0.75 \times 0.062 \mathrm{in}$.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\theta \mathrm{JJA}}$ | 556 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Lead Solder Temperature, Maximum 10 Seconds Duration | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | -55 to +150 | ${ }^{\circ} \mathrm{C}$ |

ELECTRICAL CHARACTERISTICS $\left(T_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted) (Each Diode)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |


| Reverse Breakdown Voltage $\left(\mathrm{I}_{(\mathrm{BR})}=100 \mu \mathrm{~A}\right)$ | $\mathrm{V}_{\text {(BR) }}$ | 70 | - | - | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Reverse Voltage Leakage Current $\begin{aligned} & \left(\mathrm{V}_{\mathrm{R}}=70 \mathrm{Vdc}\right) \\ & \left(\mathrm{V}_{\mathrm{R}}=25 \mathrm{Vdc}, \mathrm{~T}_{\mathrm{J}}=150^{\circ} \mathrm{C}\right) \\ & \left(\mathrm{V}_{\mathrm{R}}=70 \mathrm{Vdc}, \mathrm{~T}_{J}=150^{\circ} \mathrm{C}\right) \end{aligned}$ | $I_{\text {R }}$ | - | - | $\begin{aligned} & 2.5 \\ & 30 \\ & 50 \end{aligned}$ | $\mu \mathrm{Adc}$ |
| $\begin{aligned} & \text { Capacitance (between I/O pins) } \\ & \left(V_{R}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}\right) \end{aligned}$ | $\mathrm{C}_{\text {D }}$ | - | 0.8 | 1.5 | pF |
| Capacitance (between I/O pin and ground) $\left(\mathrm{V}_{\mathrm{R}}=0 \mathrm{~V}, \mathrm{f}=1.0 \mathrm{MHz}\right)$ | $C_{\text {D }}$ | - | 1.6 | 3 | pF |
| $\begin{aligned} & \text { Forward Voltage } \\ & \left(I_{F}=1.0 \mathrm{mAdc}\right) \\ & \left(I_{F}=10 \mathrm{mAdc}\right) \\ & \left(\mathrm{I}_{F}=50 \mathrm{mAdc}\right) \\ & \left(I_{F}=150 \mathrm{mAdc}\right) \end{aligned}$ | $V_{\text {F }}$ | - - - | - - - | $\begin{array}{r} 715 \\ 855 \\ 1000 \\ 1250 \end{array}$ | $\mathrm{mV}_{\mathrm{dc}}$ |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. Alumina $=0.4 \times 0.3 \times 0.024$ in. $99.5 \%$ alumina.
3. Include SZ-prefix devices where applicable.

## NUP4301MR6, SZNUP4301MR6

Curves Applicable to Each Cathode


Figure 1. Forward Voltage


Figure 2. Leakage Current


Figure 3. Capacitance


SC-74
CASE 318F
ISSUE P
SCALE 2:1


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[^0]:    *For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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